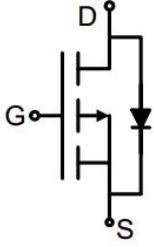
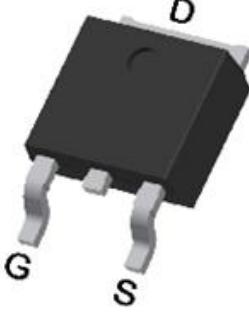


## P-Channel Enhancement Mode Power MOSFET

<p><b>Description</b></p> <p>The G40P03K uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math>, low gate charge. It can be used in a wide variety of applications.</p> <p><b>General Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS}</math> -30V</li> <li>● <math>I_D</math> (at <math>V_{GS} = -10V</math>) -40A</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = -10V</math>) &lt; 10mΩ</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = -4.5V</math>) &lt; 14mΩ</li> <li>● 100% Avalanche Tested</li> <li>● RoHS Compliant</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● Power switch</li> <li>● DC/DC converters</li> </ul>	 <p>Schematic diagram</p>  <p>TO-252</p>
-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------	----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------

<b>Ordering Information</b>			
<b>Device</b>	<b>Package</b>	<b>Marking</b>	<b>Packaging</b>
G40P03K	TO-252	G40P03	2500pcs/Reel

<b>Absolute Maximum Ratings</b> $T_C = 25^\circ\text{C}$ , unless otherwise noted			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Drain-Source Voltage	$V_{DS}$	-30	V
Continuous Drain Current	$I_D$	-40	A
Pulsed Drain Current (note1)	$I_{DM}$	-160	A
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Power Dissipation	$P_D$	78	W
Single pulse avalanche energy (note2)	$E_{AS}$	72	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 To 150	°C

<b>Thermal Resistance</b>			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	50	°C/W
Maximum Junction-to-Case	$R_{thJC}$	1.6	°C/W

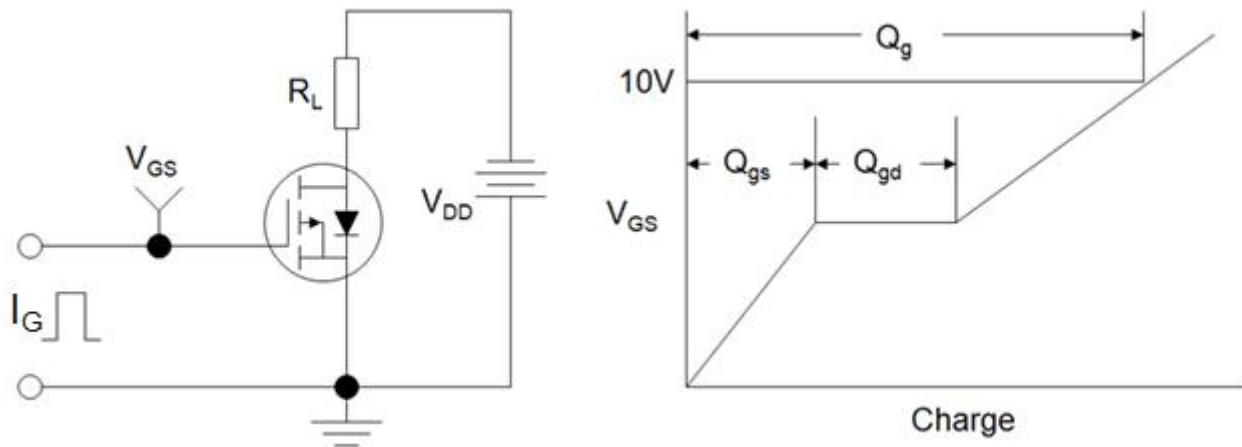
**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = -250\mu\text{A}$	-30	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = -30V, V_{GS} = 0V$	--	--	-1	$\mu\text{A}$
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{GS} = \pm 20V$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.0	-1.7	-2.5	V
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = -10V, I_D = -20\text{A}$	--	7.5	10	$\text{m}\Omega$
		$V_{GS} = -4.5V, I_D = -15\text{A}$	--	10	14	
Forward Transconductance	$g_{\text{FS}}$	$V_{DS} = -5V, I_D = -20\text{A}$	--	52	--	s
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{GS} = 0V, V_{DS} = -15V, f = 1.0\text{MHz}$	--	2622	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	348	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	346	--	
Total Gate Charge	$Q_g$	$V_{DD} = -15V, I_D = -20\text{A}, V_{GS} = -10V$	--	50	--	$\text{nC}$
Gate-Source Charge	$Q_{gs}$		--	9	--	
Gate-Drain Charge	$Q_{gd}$		--	12	--	
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD} = -15V, I_D = -20\text{A}, R_G = -3\Omega$	--	18	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	12.5	--	
Turn-off Delay Time	$t_{d(\text{off})}$		--	125	--	
Turn-off Fall Time	$t_f$		--	66	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_s$	$T_C = 25^\circ\text{C}$	--	--	-40	A
Body Diode Voltage	$V_{SD}$	$T_J = 25^\circ\text{C}, I_{SD} = -20\text{A}, V_{GS} = 0V$	--	--	-1.2	V
Reverse Recovery Charge	$Q_{rr}$	$I_F = -20\text{A}, V_{GS} = 0V$ $di/dt = -500\text{A/us}$	--	62	--	$\text{nC}$
Reverse Recovery Time	Tr		--	32	--	ns

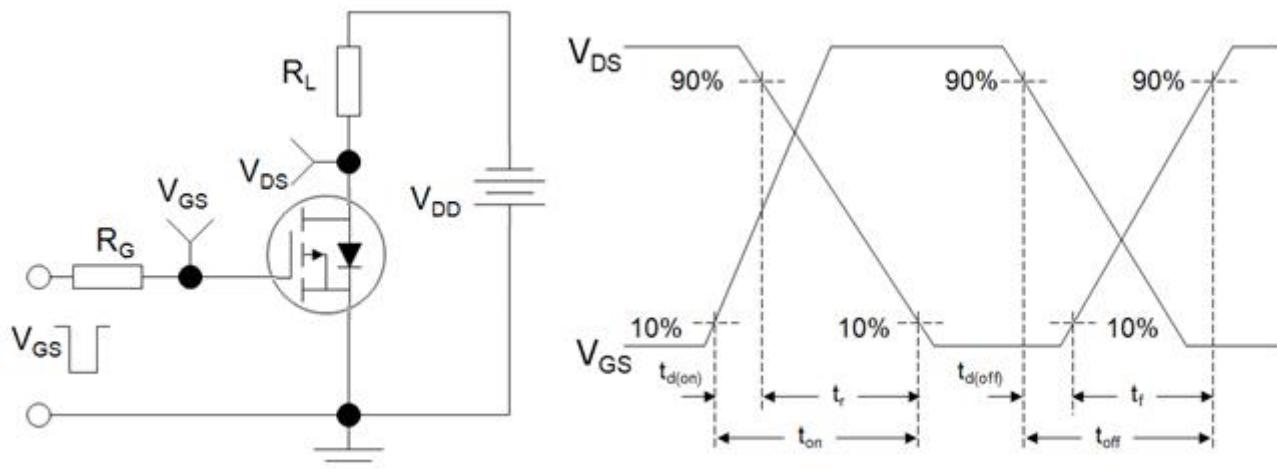
**Notes**

- Repetitive Rating: Pulse width limited by maximum junction temperature
- EAS condition :  $T_J=25^\circ\text{C}$ ,  $VDD=-30V$ ,  $VGS=-10V$ ,  $L=0.5\text{mH}$ ,  $R_g=25\Omega$
- Identical low side and high side switch with identical  $R_G$

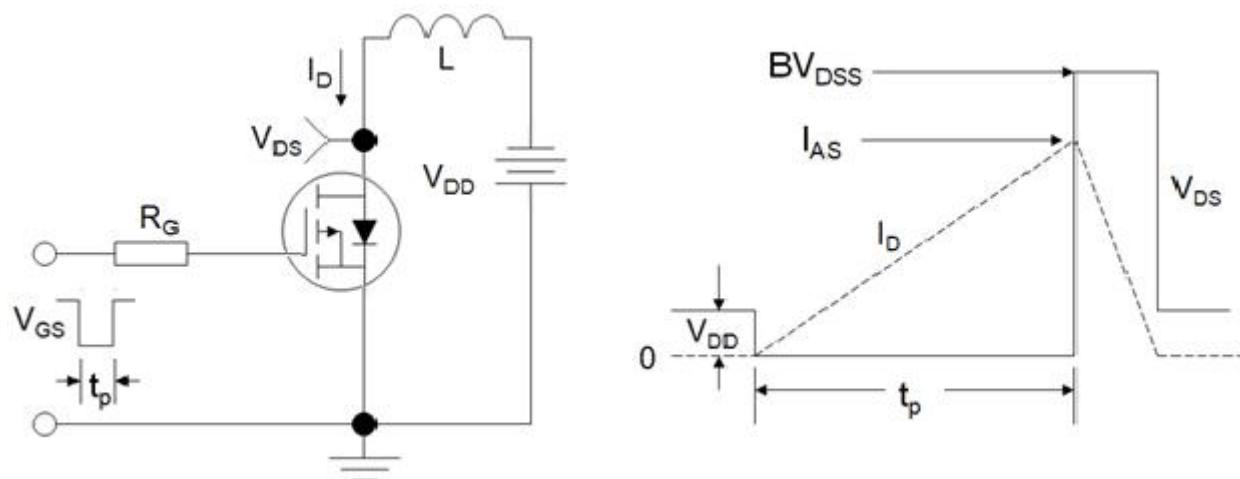
Gate Charge Test Circuit



Switch Time Test Circuit

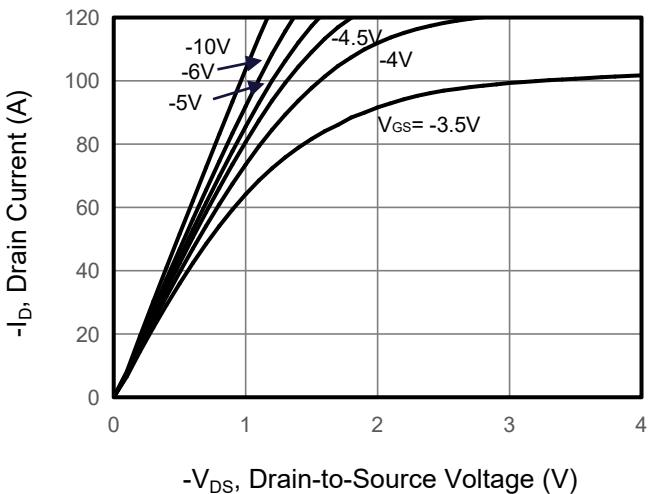


EAS Test Circuit

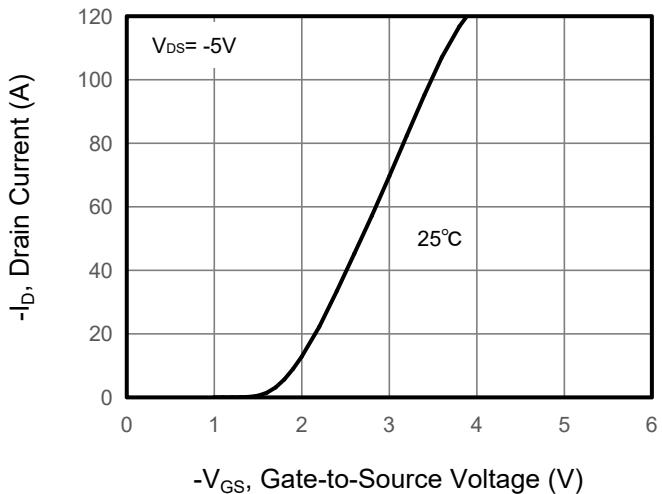


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

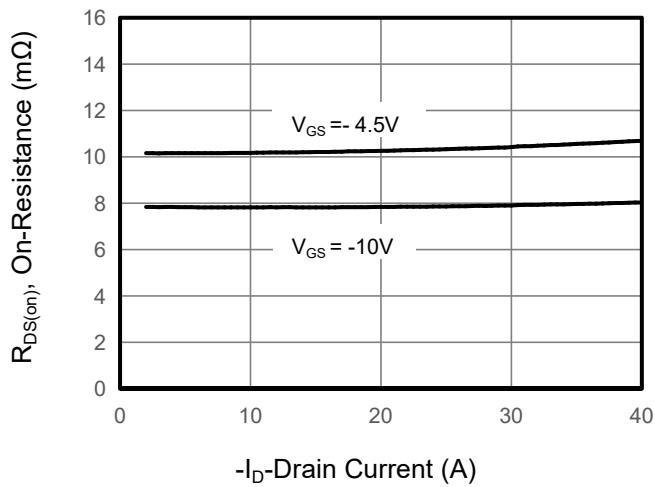
**Figure 1. Output Characteristics**



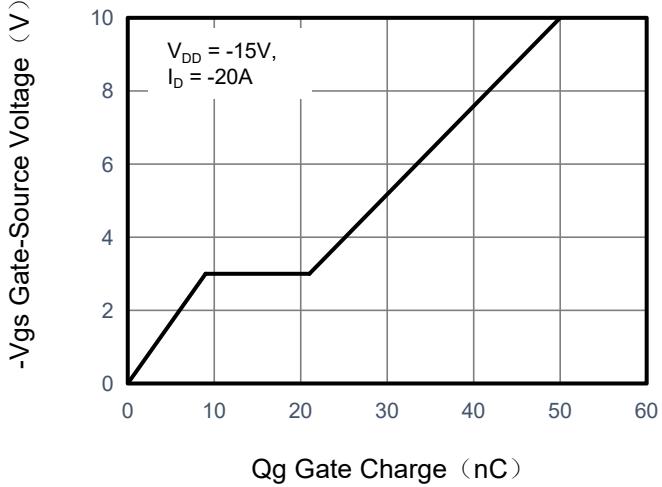
**Figure 2. Transfer Characteristics**



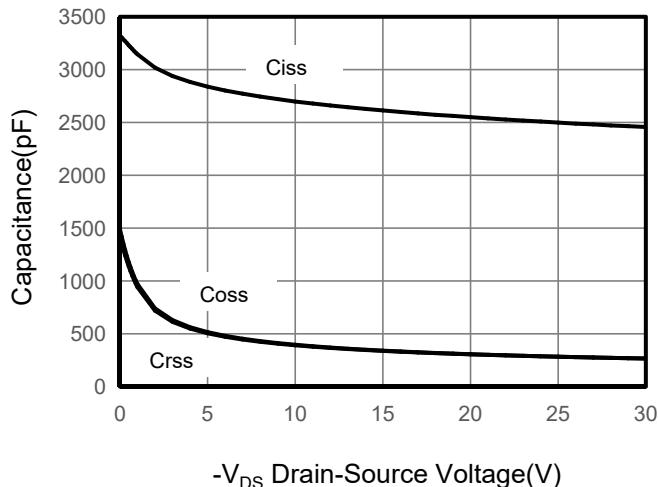
**Figure 3. Drain Source On Resistance**



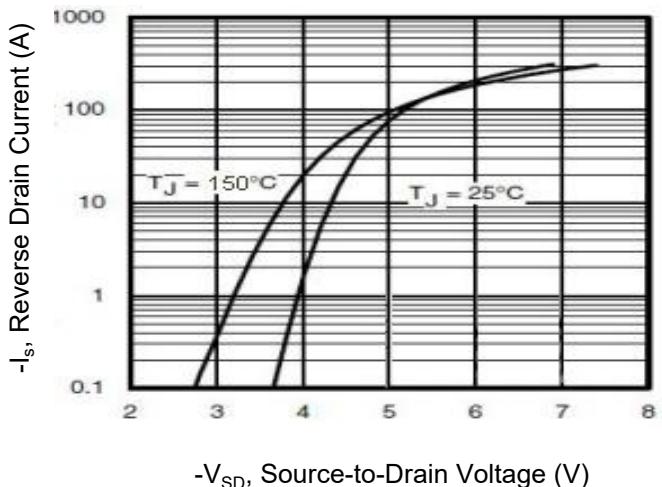
**Figure 4. Gate Charge**



**Figure 5. Capacitance**

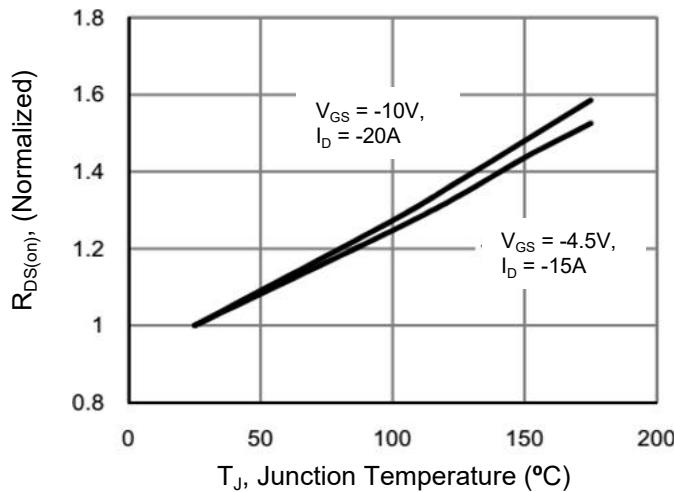


**Figure 6. Source-Drain Diode Forward**

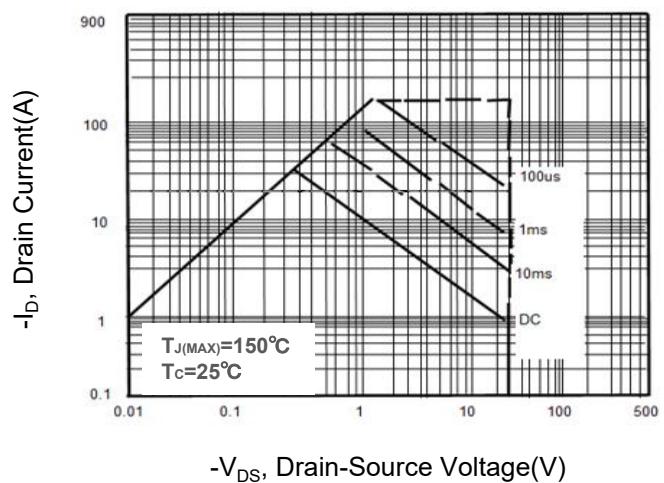


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

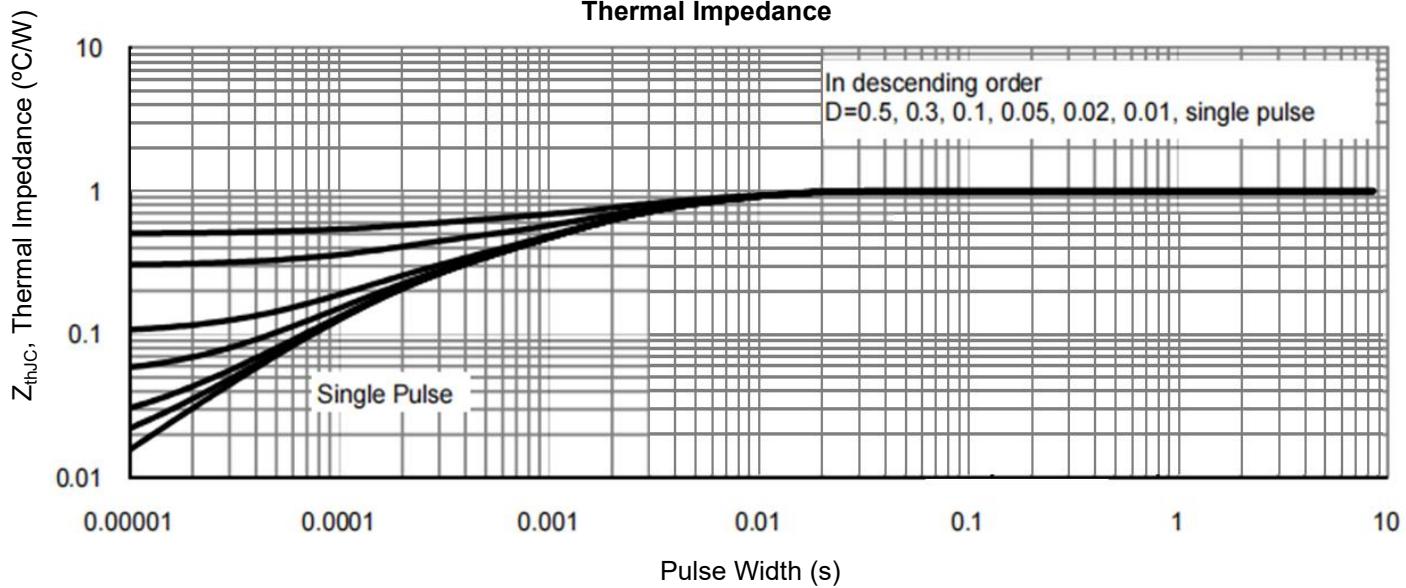
**Figure 7. Drain-Source On-Resistance**



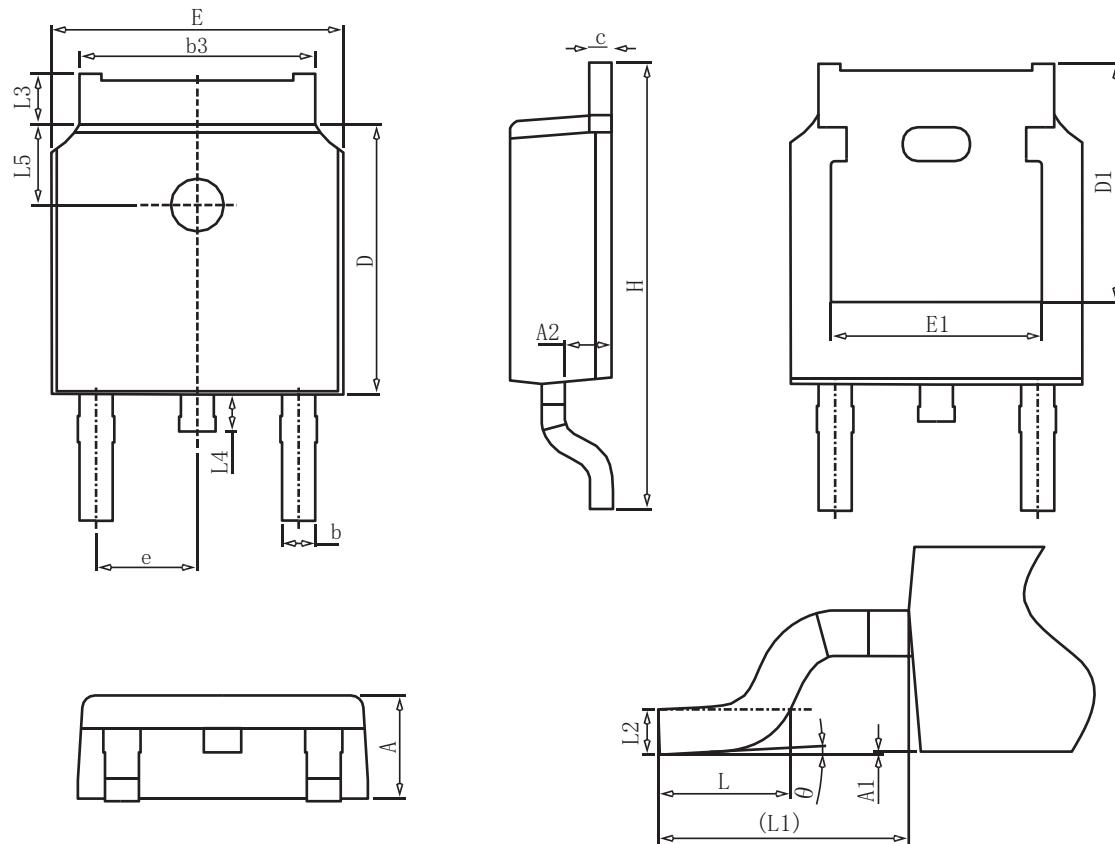
**Figure 10. Safe Operation Area**



**Figure 9. Normalized Maximum Transient Thermal Impedance**



## TO-252 Package information



## COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	2.20	2.30	2.40
A1	0.00	-	0.20
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b3	5.20	5.33	5.50
c	0.43	0.53	0.63
D	5.98	6.10	6.22
D1	5.30REF		
E	6.40	6.60	6.80
E1	4.63	-	-
e	2.286BSC		
H	9.40	10.10	10.50
L	1.38	1.50	1.75
L1	2.90REF		
L2	0.51BSC		
L3	0.88	-	1.28
L4	0.50	-	1.00
L5	1.65	1.80	1.95
θ	0°	-	8°